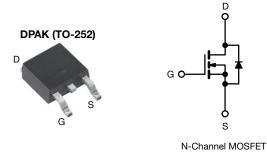
# SiHD690N60E

Vishay Siliconix



**E Series Power MOSFET** 



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.60			
Q <sub>g</sub> max. (nC)	12				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	3				
Configuration	Single				

### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	DPAK (TO-252)			
Lead (Pb)-free and halogen-free	SiHD690N60E-GE3			

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	Ι <sub>D</sub>	6.4	А
	VGS at 10 V	T <sub>C</sub> = 100 °C		4.0	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	11	
Linear derating factor				0.5	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	9	mJ
Maximum power dissipation			PD	62.5	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		alı . / alt	70		
Reverse diode dv/dt d			dv/dt -	17	V/ns
Soldering recommendations (peak temperature)	С	For 10 s		260	°C

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 0.8 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 



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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			°C AN			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 2.0			°C/W			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, t	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3.0	-	5.0	V
		, v	√ <sub>GS</sub> = ± 20	V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30	V	-	-	± 1	μA
Zara gata valtaga drain overant		V <sub>DS</sub> =	600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	١ <sub>c</sub>	<sub>0</sub> = 2.0 A	-	0.60	0.70	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	= 2.0 A	-	1.2	-	S
Dynamic					•	•	•	•
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	347	-		
Output capacitance	C <sub>oss</sub>	· ·	$V_{\rm DS} = 0.0$ V, $V_{\rm DS} = 100$ V,		-	24	-	1
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	17	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	86	-	1	
Total gate charge	Qg				-	8	12	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_{\rm D} = 2.0$	A, V <sub>DS</sub> = 480 V	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	3	-	
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	t <sub>r</sub>	- V <sub>DD</sub> =	480 V, I <sub>D</sub> =	= 2.0 A,	-	9	18	
Turn-off delay time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	19	38	ns
Fall time	t <sub>f</sub>			-	22	44	1	
Gate input resistance	R <sub>g</sub>	f = 1	MHz, oper	n drain	1.1	2.3	4.6	Ω
Drain-Source Body Diode Characterist		•						
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET sym showing the	MOSFET symbol showing the		-	-	6.4	_
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	11	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 2.0 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	146	292	ns
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 2.0 A, di/dt = 100 A/µs, V <sub>B</sub> = 25 V		-	1.0	2.0	μC	
Reverse recovery current	I <sub>RRM</sub>	ai/at = 1	100 A/µs, \	/ <sub>R</sub> = ∠5 V	-	13	-	A
,				1		I	1	

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



# SiHD690N60E

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

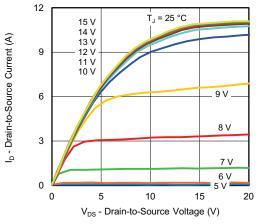


Fig. 1 - Typical Output Characteristics

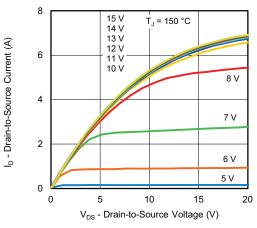


Fig. 2 - Typical Output Characteristics

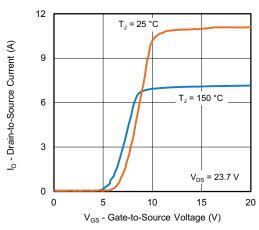


Fig. 3 - Typical Transfer Characteristics

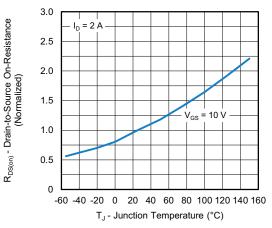


Fig. 4 - Normalized On-Resistance vs. Temperature

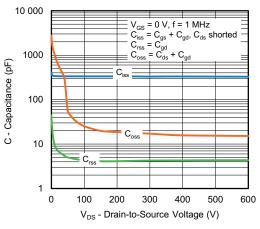


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

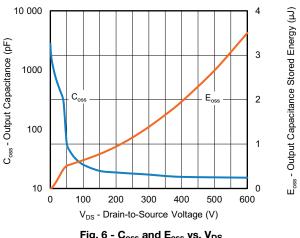


Fig. 6 - Coss and Eoss vs. VDS

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Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

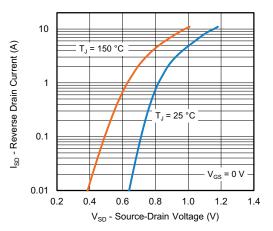


Fig. 8 - Typical Source-Drain Diode Forward Voltage

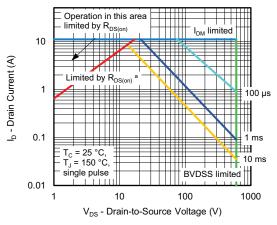


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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7

6

5

4

3 2

1

0

25

50

I<sub>D</sub> - Drain Current (A)

SiHD690N60E



100

125

150

75

Fig. 10 - Maximum Drain Current vs. Case Temperature

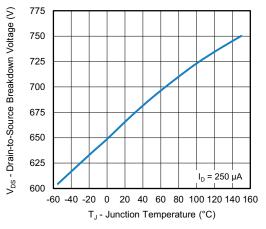


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

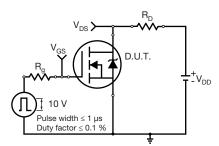


Fig. 13 - Switching Time Test Circuit

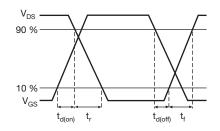


Fig. 14 - Switching Time Waveforms

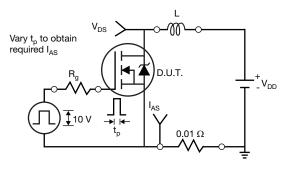


Fig. 15 - Unclamped Inductive Test Circuit

VDD V<sub>DS</sub>  $I_{AS}$ 

Fig. 16 - Unclamped Inductive Waveforms

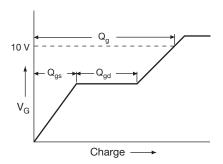


Fig. 17 - Basic Gate Charge Waveform

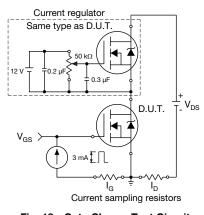


Fig. 18 - Gate Charge Test Circuit

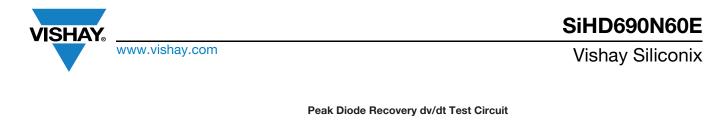
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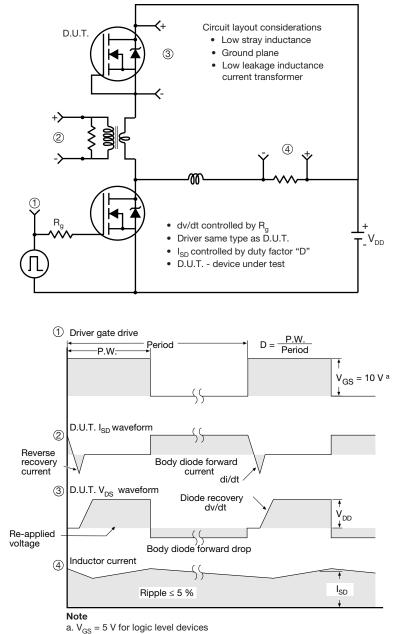


Fig. 19 - For N-Channel

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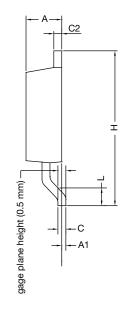


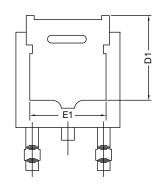


**TO-252AA Case Outline** 

### VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01 1.52			

### Note

• Dimension L3 is for reference only



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## VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74 ref.		
L2	0.51 BSC		
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25° 35°		

### Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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